

AMENDMENTS TO THE CLAIMS

1. **(Currently amended)** A tape with a built-in IC chip used for a sheet with a built-in IC chip, comprising: a tape body; and an IC chip provided with the tape body, wherein the tape body comprises a first base material and a second base material, wherein the second base material has a plurality of penetrating openings, and

a part or all of the IC chip is inserted in the penetrating openings, whereby the IC chip is to be embedded in the tape body in a non-exposed state.

2. **(Canceled)**

3. **(Canceled)**

4. **(Currently amended)** A tape with a built-in IC chip according to ~~any one of claims 1-3~~ claim 1, wherein the IC chip is fixed to the tape body by a resin.

5. **(Canceled)**

6. **(Currently amended)** A sheet with a built-in IC chip, comprising: a sheet-like material; and a tape with a built-in IC chip according to ~~any one of claims 1-3~~ claim 1 which is inserted into the sheet-like material.

7. **(Original)** A sheet with a built-in IC chip according to claim 6, wherein the tape with a built-in IC chip is embedded in the sheet-like material formed of multilayer paper.

8. **(Currently amended)** A sheet with a built-in IC chip according to claim 7, wherein a groove is formed on the sheet-like material, and the tape is attached to the groove at least a portion of a middle layer of the multilayer paper which corresponds to a position for embedding the IC chip is formed without attaching a sheet of raw material to the portion or discontinuously attaching the sheet of raw material.

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9. **(Original)** A sheet with a built-in IC chip according to claim 6, wherein a part of the tape with a built-in IC chip is in an exposed state.

10. **(Currently amended)** A sheet with a built-in IC chip, comprising: a sheet-like material; and a tape with a built-in IC chip according to ~~any one of claims 1-3~~ claim 1 which is attached to the sheet-like material.